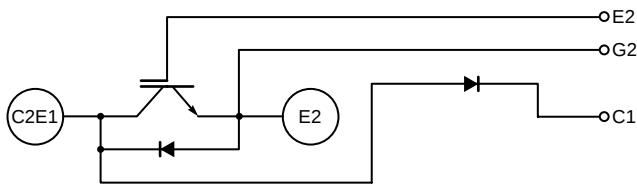
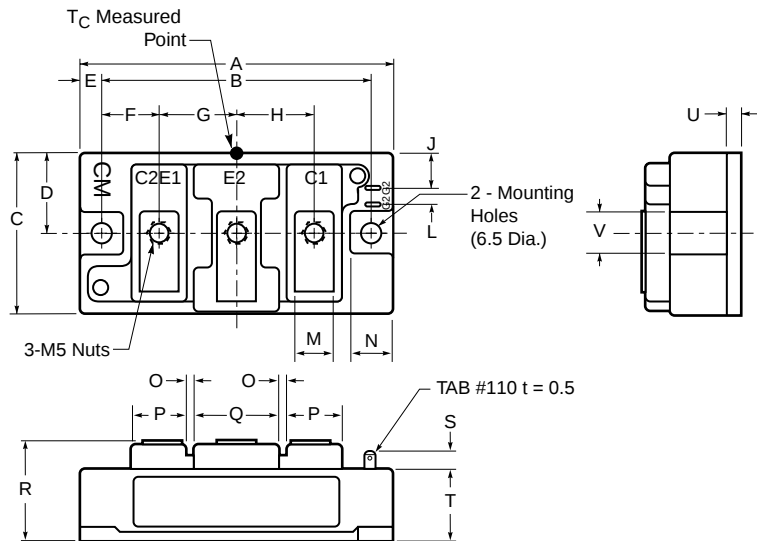


MITSUBISHI IGBT MODULES
CM75E3U-24H
 HIGH POWER SWITCHING USE
 INSULATED TYPE



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	3.7	94.0
B	3.15±0.01	80.0±0.25
C	1.89	48.0
D	0.94	24.0
E	0.28	7.0
F	0.67	17.0
G	0.91	23.0
H	0.91	23.0
J	0.43	11.0
L	0.16	4.0

Dimensions	Inches	Millimeters
M	0.47	12.0
N	0.53	13.5
O	0.1	2.5
P	0.63	16.0
Q	0.98	25.0
R	1.18 +0.04/-0.02	30.0 +1.0/-0.5
S	0.3	7.5
T	0.83	21.2
U	0.16	4.0
V	0.51	13.0



Description:

Mitsubishi IGBT Modules are designed for use in switching applications. Each module consists of one IGBT having a reverse-connected super-fast recovery free-wheel diode and an anode-collector connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:

- ☐ Low Drive Power
- ☐ Low $V_{CE(sat)}$
- ☐ Discrete Super-Fast Recovery Free-Wheel Diode
- ☐ High Frequency Operation
- ☐ Isolated Baseplate for Easy Heat Sinking

Application:

- ☐ Brake

Ordering Information:

Example: Select the complete module number you desire from the table - i.e. CM75E3U-24H is a 1200V (V_{CES}), 75 Ampere IGBT Module.

Type	Current Rating Amperes	V_{CES} Volts (x 50)
CM	75	24

CM75E3U-24H

HIGH POWER SWITCHING USE
INSULATED TYPEAbsolute Maximum Ratings, $T_j = 25\text{ }^{\circ}\text{C}$ unless otherwise specified

	Symbol	Ratings	Units
Junction Temperature	T_j	-40 to 150	$^{\circ}\text{C}$
Storage Temperature	T_{stg}	-40 to 125	$^{\circ}\text{C}$
Collector-Emitter Voltage (G-E SHORT)	V_{CES}	1200	Volts
Gate-Emitter Voltage (C-E SHORT)	V_{GES}	± 20	Volts
Collector Current ($T_c = 25^{\circ}\text{C}$)	I_c	75	Amperes
Peak Collector Current	I_{CM}	150*	Amperes
Emitter Current** ($T_c = 25^{\circ}\text{C}$)	I_E	75	Amperes
Peak Emitter Current**	I_{EM}	150*	Amperes
Maximum Collector Dissipation ($T_c = 25^{\circ}\text{C}$, $T_j \leq 150^{\circ}\text{C}$)	P_c	600	Watts
Mounting Torque, M5 Main Terminal	—	2.5 ~ 3.5	N · m
Mounting Torque, M6 Mounting	—	3.5 ~ 4.5	N · m
Weight	—	310	Grams
Isolation Voltage (Main Terminal to Baseplate, AC 1 min.)	V_{iso}	2500	Vrms

* Pulse width and repetition rate should be such that the device junction temperature (T_j) does not exceed $T_{j(\text{max})}$ rating.

**Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDI).

Static Electrical Characteristics, $T_j = 25\text{ }^{\circ}\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	I_{CES}	$V_{\text{CE}} = V_{\text{CES}}$, $V_{\text{GE}} = 0\text{V}$	—	—	1	mA
Gate Leakage Voltage	I_{GES}	$V_{\text{GE}} = V_{\text{GES}}$, $V_{\text{CE}} = 0\text{V}$	—	—	0.5	μA
Gate-Emitter Threshold Voltage	$V_{\text{GE(th)}}$	$I_c = 7.5\text{mA}$, $V_{\text{CE}} = 10\text{V}$	4.5	6	7.5	Volts
Collector-Emitter Saturation Voltage	$V_{\text{CE(sat)}}$	$I_c = 75\text{A}$, $V_{\text{GE}} = 15\text{V}$, $T_j = 25^{\circ}\text{C}$	—	2.9	3.7	Volts
		$I_c = 75\text{A}$, $V_{\text{GE}} = 15\text{V}$, $T_j = 125^{\circ}\text{C}$	—	2.85	—	Volts
Total Gate Charge	Q_G	$V_{\text{CC}} = 600\text{V}$, $I_c = 75\text{A}$, $V_{\text{GE}} = 15\text{V}$	—	280	—	nC
Emitter-Collector Voltage**	V_{EC}	$I_E = 75\text{A}$, $V_{\text{GE}} = 0\text{V}$	—	—	3.2	Volts
Emitter-Collector Voltage	V_{FM}	$I_F = 75\text{A}$, Clamp Diode Part	—	—	3.2	Volts

**Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDI).

Dynamic Electrical Characteristics, $T_j = 25\text{ }^{\circ}\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Input Capacitance	C_{ies}	$V_{\text{CE}} = 10\text{V}$, $V_{\text{GE}} = 0\text{V}$	—	—	11	nF
Output Capacitance	C_{oes}		—	—	3.7	nF
Reverse Transfer Capacitance	C_{res}		—	—	2.2	nF
Resistive	Turn-on Delay Time	$V_{\text{CC}} = 600\text{V}$, $I_c = 75\text{A}$, $V_{\text{GE1}} = V_{\text{GE2}} = 15\text{V}$, $R_G = 4.2\Omega$, Resistive	—	—	100	ns
	Rise Time		—	—	200	ns
Switch	Turn-off Delay Time	Load Switching Operation	—	—	250	ns
Times	Fall Time		—	—	350	ns
Diode Reverse Recovery Time**	t_{rr}	$I_E = 75\text{A}$, $di_E/dt = -150\text{A}/\mu\text{s}$	—	—	300	ns
Diode Reverse Recovery Charge**	Q_{rr}	$I_E = 75\text{A}$, $di_E/dt = -150\text{A}/\mu\text{s}$	—	0.41	—	μC
Diode Reverse Recovery Time	t_{rr}	$I_F = 75\text{A}$, Clamp Diode Part	—	—	300	ns
Diode Reverse Recovery Charge	Q_{rr}	$di_F/dt = -150\text{A}/\mu\text{s}$	—	0.41	—	μC

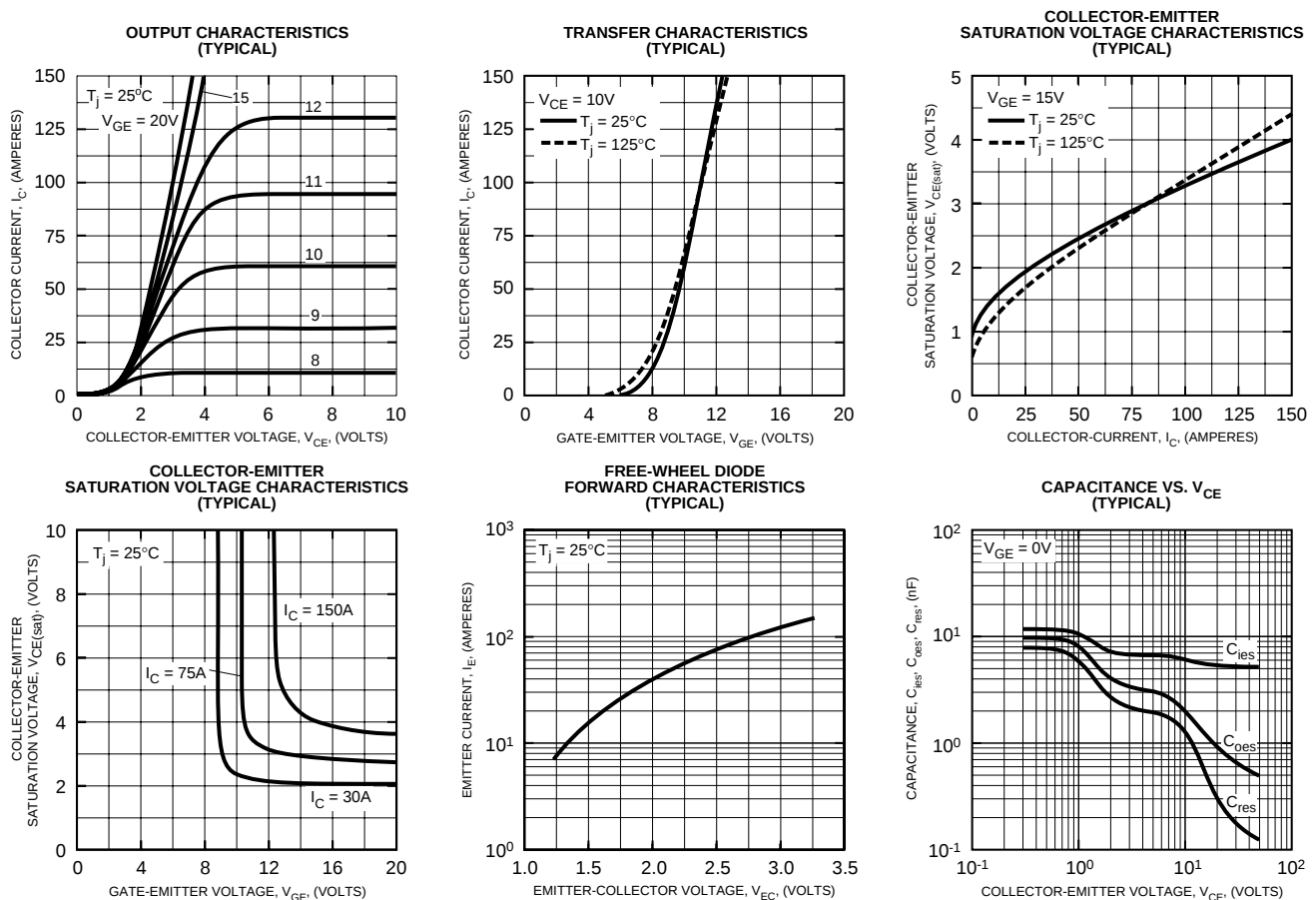
**Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDI).

CM75E3U-24H

HIGH POWER SWITCHING USE
INSULATED TYPE

Thermal and Mechanical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

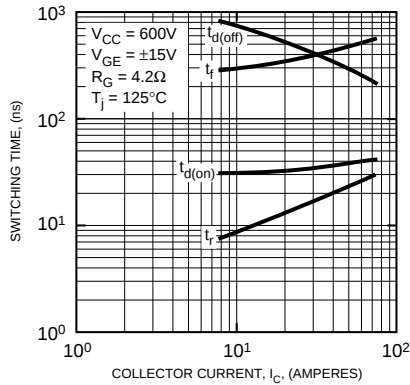
Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case	$R_{th(j-c)Q}$	Per IGBT Module	—	—	0.21	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case	$R_{th(j-c)D}$	Per FWDi Module	—	—	0.47	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case	$R_{th(j-c)}$	Clamp Diode Part	—	—	0.47	$^\circ\text{C/W}$
Contact Thermal Resistance	$R_{th(c-f)}$	Per Module, Thermal Grease Applied	—	0.035	—	$^\circ\text{C/W}$



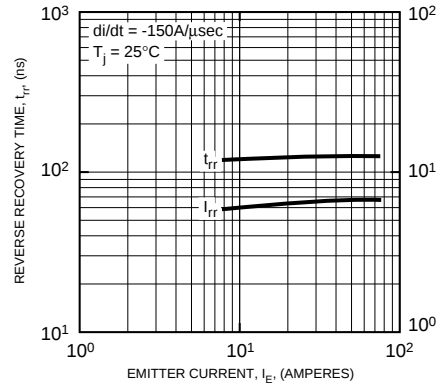
CM75E3U-24H

HIGH POWER SWITCHING USE
INSULATED TYPE

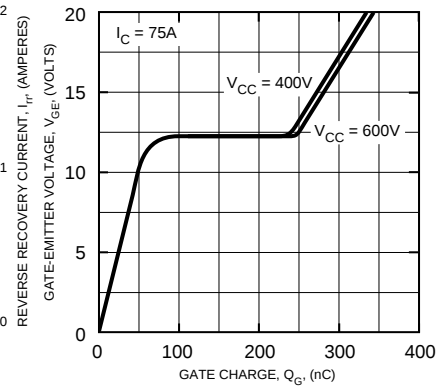
HALF-BRIDGE
SWITCHING CHARACTERISTICS
(TYPICAL)



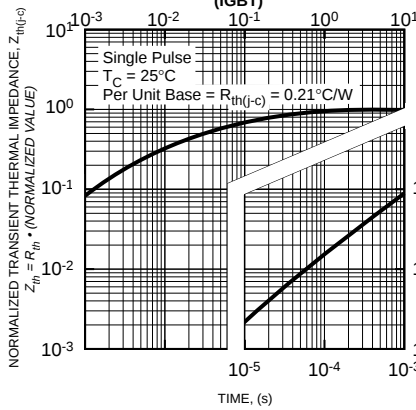
REVERSE RECOVERY CHARACTERISTICS
(TYPICAL)



GATE CHARGE, V_{GE}



TRANSIENT THERMAL
IMPEDANCE CHARACTERISTICS
(IGBT)



TRANSIENT THERMAL
IMPEDANCE CHARACTERISTICS
(FWDI)

